

0201 SERIES THICK FILM CHIP RESISTOR

1. Scope

This specification applies to 0.3mm x 0.6mm (0201) size, fixed metal film chip resistors rectangular type for use in electronic equipment.

2. Type Designation

PFR03 S — □□□ — □

(1) (2) (3)

PFR03 S — 000 — □

(1) (2) (3)

Where (1) Series No.

(2) Nominal resistance value :

For example –

Three digits of number (E-24 Series)

000 = Jumper

100 = 10Ω

102 = 1kΩ

Four digits of number (E-96 Series)

11R3 = 11.3Ω

1131 = 1.13kΩ

(3) Tolerance of Resistance

X = Jumper(Below 50mΩ)

F = ± 1.0%

G = ± 2.0%

J = ± 5.0%

3. Electrical Specifications

Table 1. :

*Power rating	1/20W				
Resistance Values	E-24 series , E-96 series		E-24 series		
Resistance Tolerance	± 1.0%(F)		± 5.0%(J)	± 2.0%(G) , ± 5.0%(J)	
Resistance Range (Ω)	10 ~ 91	100 ~ 1M	1.0 ~ 9.1	10 ~ 91	100 ~ 10M
Temperature Coefficient of Resistance ppm/°C	± 300	± 200	+600 ~ -200	± 300	± 200
Operating temperature range	- 55°C to + 125°C				
Max. operating voltage**	25V				

Note: *Package Power Temperature Derating Curve

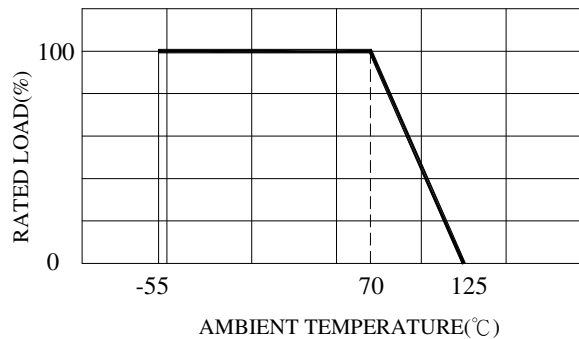


Figure 1. : Power Temperature Derating Cure

Note: **Resistors shall have a rated DC or AC(rms.) continuous operating voltage corresponding to the power rating, as calculated from the following formula

$$V = \sqrt{P \times R}$$

Where V : Rated voltage (V)

P : Rated power (W)

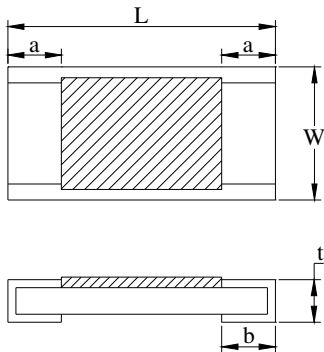
R : Nominal resistance (Ω)

If the voltage so obtained exceeds the maximum operating voltage, this maximum voltage shall be the rated voltage.

Table 2. : Jumper:

Resistance Tolerance	Below 50 mΩ
Rated current	1A
Operating Temperature Range	-55°C to 125°C

4. Construction and Physical Dimension



Code Letter	Dimension
L	0.6 ± 0.03
W	0.3 ± 0.03
t	0.23 ± 0.03
a	0.10 ± 0.05
b	0.15 ± 0.05

Unit : mm

5. Marking

No marking on the protect coating

6. Life Tests

6-1 Electrical

Item	Specification and Requirement		Test Method
	Resistor	Jumper	
Short Time Overload	$\Delta R: \pm (2\% + 0.1)\Omega$ Without damage by flashover, spark, arcing, burning or breakdown	Max. 50m Ω	(1) Applied voltage: 2.5 x rated voltage or 2 x maximum operating voltage which ever is less (2) Test time : 5 seconds
Insulation Resistance	Over 100 M Ω on Overcoat layer face up Over 1,000 M Ω on Substrate side face up		(1) Setup as figure 2 (2) Test voltage: 100 V _{DC} (3) Test time: 60 + 10 / -0 seconds
Voltage Proof	$\Delta R: \pm (2\% + 0.1)\Omega$ Without damage by flashover, spark, arcing, burning or breakdown	Max. 50m Ω	(1) Setup as figure 2 (2) Test voltage: 100 V _{AC} (rms.) (3) Test time: 60 + 10 / -0 seconds

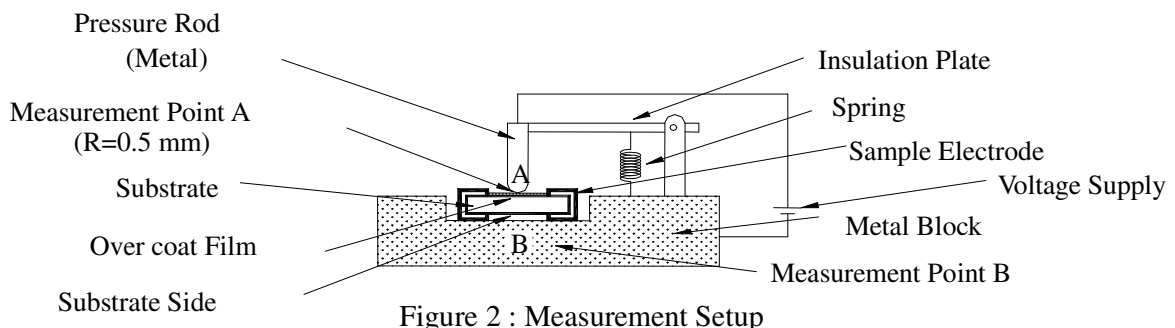


Figure 2 : Measurement Setup

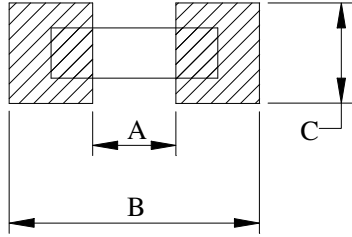
6-2 Mechanical

Item	Specification and Requirement		Test Method
	Resistor	Jumper	
Solderability	The surface of terminal immersed shall be minimum of 95% covered with a new coating of solder		Solder bath: After immersing in flux, dip in $245 \pm 5^{\circ}\text{C}$ molten solder bath for 2 ± 0.5 seconds
Resistance to Solder Heat	$\Delta R: \pm (1.0\% + 0.05)\Omega$ Without distinct deformation in appearance	Max. 50m Ω	(1) Pre-heat: 100~110 $^{\circ}\text{C}$ for 30 seconds (2) Immersed at solder bath of $270 \pm 5^{\circ}\text{C}$ for 10 ± 1 seconds (3) Measuring resistance 1 hour after test
Vibration	$\Delta R: \pm (0.5\% + 0.05)\Omega$ Without mechanical damage such as break		(1) Vibration frequency: 10Hz to 55Hz to 10Hz in 60 seconds as a period (2) Vibration time: period cycled for 2 hours in each of 3 mutual perpendicular directions (3) Amplitude: 1.5mm
Shock	$\Delta R: \pm (0.25\% + 0.05)\Omega$ Without mechanical damage such as break		(1) Peak value: 490N (2) Duration of pulse: 11ms (3) 3 times in each positive and negative direction of 3 mutual perpendicular directions
Bending Test	$\Delta R: \pm (1.0\% + 0.05)\Omega$ Without mechanical damage such as break		Bending value: 3 mm for 30 ± 1 seconds
Solvent Resistance	Marking should be legible Without mechanical and distinct damage in appearance	Max. 50m Ω	(1) Solvent: Trichloroethane or Isopropyl alcohol (2) Immersed in solvent at room temperature for 90 seconds

6-3 Endurance

Item	Specification and Requirement		Test Method
	Resistor	Jumper	
Rapid change of Temperature	$\Delta R: \pm (1.0\% + 0.05)\Omega$ Without distinct damage in appearance	Max. 50m Ω	(1) Repeat 5 cycle as follow: (-55 \pm 3 $^{\circ}$ C, 30minutes) →(Room temperature, 2~3 minutes) → (+125 \pm 2 $^{\circ}$ C, 30minutes) →(Room temperature, 2~3 minutes) (2) Measuring resistance 1 hour after test
Moisture with Load	$\Delta R: \pm (5.0\% + 0.1)\Omega$ Without distinct damage in appearance Marking should be legible	Max. 50m Ω	(1) Environment condition: 40 \pm 2 $^{\circ}$ C, 90~95% RH (2) Applied Voltage: rated voltage (3) Test period: (1.5 hour ON) →(0.5 hour OFF) cycled for total 1,000 + 48 / - 0 hours (4) Measuring resistance 1 hour after test
Load Life	$\Delta R: \pm (5.0\% + 0.1)\Omega$ Without distinct damage in appearance	Max. 100m Ω	(1) Test temperature: 70 \pm 2 $^{\circ}$ C (2) Applied Voltage: rated Voltage (3) Test period: (1.5 hour ON) →(0.5 hour OFF) cycled for total 1,000 + 48 / - 0 hours (4) Measuring resistance 1 hour after test
Low Temperature Store	$\Delta R: \pm (5.0\% + 0.1)\Omega$ Without distinct damage in appearance	Max. 100m Ω	(1) Store temperature: -55 \pm 3 $^{\circ}$ C for total 1,000 + 48 / - 0 hours (2) Measuring resistance 1 hour after test
High Temperature Store	$\Delta R: \pm (5.0\% + 0.1)\Omega$ Without distinct damage in appearance	Max. 100m Ω	(1) Store temperature: +125 \pm 2 $^{\circ}$ C for total 1,000 + 48 / - 0 hours (2) Measuring resistance 1 hour after test

7. Recommend Land Pattern Dimensions



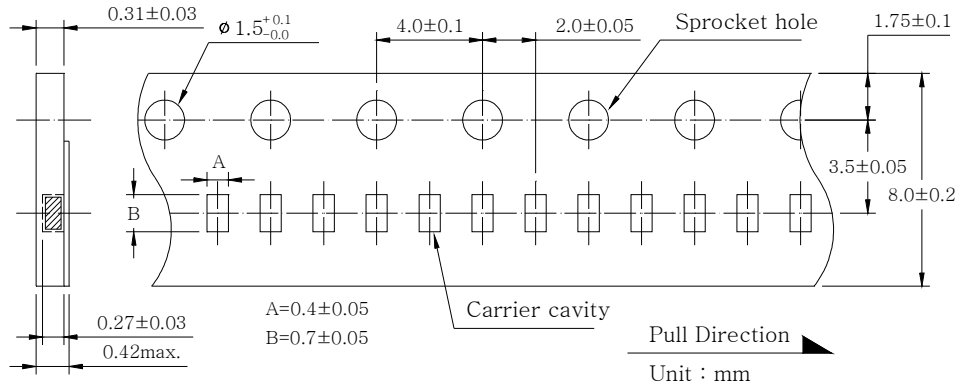
A	0.3
B	1.0
C	0.3 ~ 0.7

Unit : mm

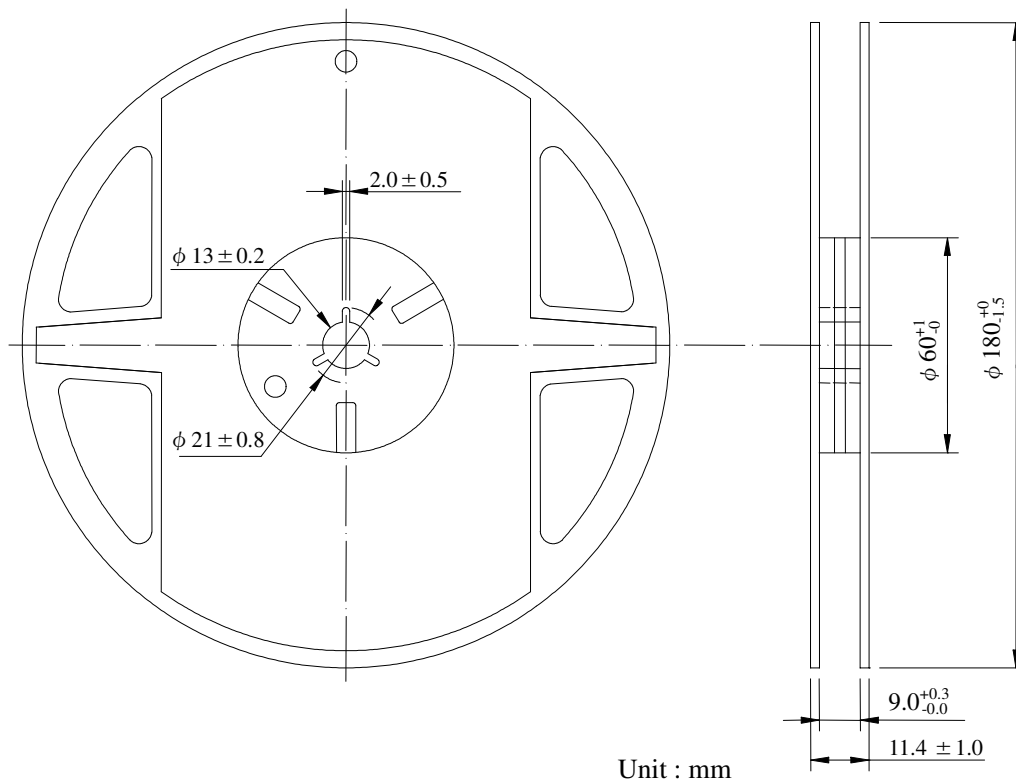
8. Packaging

8-1 Dimensions

8-1-1 Tape packaging dimensions



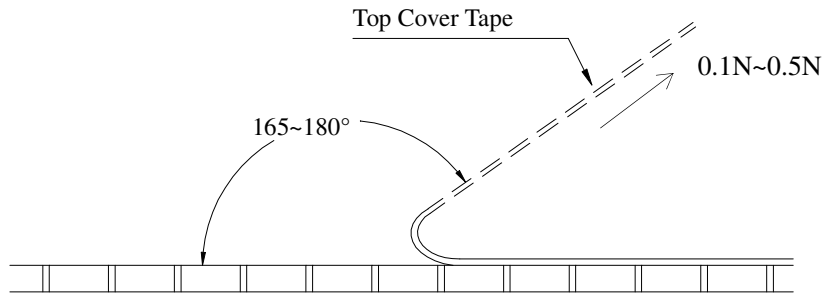
8-1-2 Reel dimensions



8-2 Peel force of top cover tape

The peel speed shall be about 300 mm/min.

The peel force of top cover tape shall be between 0.1 to 0.5 N.



8-3 Numbers of taping

10,000 pieces/reel

8-4 Making

The following items shall be marked on the reel.

- (1) Type designation.
- (2) Quantity
- (3) Manufacturing date code
- (4) Manufacturer's name

9. Care note

9-1 Care note for storage

- (1) Chip resistor shall be stored in a room where temperature and humidity must be controlled. (temperature 5 to 35°C, humidity 45 to 85% RH) However, a humidity keep it low, as it is possible.
- (2) Chip resistor shall be stored as direct sunshine doesn't hit on it.
- (3) Chip resistor shall be stored with no moisture, dust, a material that will make solderability inferior, and a harmful gas (Chloridation hydrogen, sulfurous acid gas, and sulfuration hydrogen)

9-2 Care note for operating and handling

- (1) It is necessary to protect the edge and protection coat of resistors from mechanical stress.
- (2) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
- (3) Resistors shall be used with in rated range shown in specification. Especially, if voltage more than specified value will be loaded to resistor, there is a case it will make damage for machine because of temperature rise depending on generating of heat, and increase resistance value or breaks.
- (4) In case that resistor is loaded a rated voltage, it is necessary to confirms temperature of a resistor and to reduce a load power according to load reduction curve, because a temperature rise of a resistor depends on influence of heat from mounting density and neighboring element.
- (5) Observe Limiting element voltage and maximum overload voltage specified in each specification
- (6) If there is possibility that a large voltage (pulse voltage, shock voltage) charge to resistor, it is necessary that operating condition shall be set up before use.